



Material Content Data Sheet



Halogen-Free

Sales Product Name	ISP2XEP10LM	Issued	08. February 2022
MA#	MA005421248		
Package	PG-SOT223-4-21	Weight*	113.51 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	tin	7440-31-5	0.004			39	
	noble metal	gold	7440-57-5	0.017	0.02		151	
	inorganic material	silicon	7440-21-3	0.261	0.23	0.25	2299	2489
leadframe	inorganic material	silicon	7440-21-3	0.010	0.01		89	
	non noble metal	titanium	7440-32-6	0.051	0.04		447	
	non noble metal	chromium	7440-47-3	0.152	0.13		1340	
	non noble metal	copper	7440-50-8	50.489	44.48	44.66	444801	446677
wire	non noble metal	copper	7440-50-8	0.073	0.06	0.06	645	645
encapsulation	organic material	carbon black	1333-86-4	0.605	0.53		5328	
	plastics	epoxy resin	-	9.071	7.99		79916	
	inorganic material	silicondioxide	60676-86-0	50.799	44.77	53.29	447528	532772
leadfinish	non noble metal	tin	7440-31-5	1.464	1.29	1.29	12898	12898
plating	noble metal	silver	7440-22-4	0.513	0.45	0.45	4519	4519
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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